## International IOR Rectifier

## IRLML5203PbF

#### HEXFET® Power MOSFET

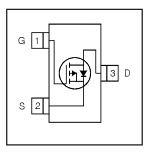
Г	V <sub>DSS</sub>	$R_{DS(on)}$ max (m $\Omega$ )	I <sub>D</sub>
	-30V	98@V <sub>GS</sub> = -10V	-3.0A
		165@V <sub>GS</sub> = -4.5V	-2.6A

- Ultra Low On-Resistance
- P-Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- Low Gate Charge
- Lead-Free
- Halogen-Free

#### **Description**

These P-channel MOSFETs from International Rectifier utilize advanced processing techniques to achieve the extremely low on-resistance per silicon area. This benefit provides the designer with an extremely efficient device for use in battery and load management applications.

A thermally enhanced large pad leadframe has been incorporated into the standard SOT-23 package to produce a HEXFET Power MOSFET with the industry's smallest footprint. This package, dubbed the Micro3<sup>TM</sup>, is ideal for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro3 allows it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards. The thermal resistance and power dissipation are the best available.





#### **Absolute Maximum Ratings**

3		
Parameter	Max.	Units
Drain- Source Voltage	-30	V
Continuous Drain Current, V <sub>GS</sub> @ -10V	-3.0	
Continuous Drain Current, V <sub>GS</sub> @ -10V	-2.4	A
Pulsed Drain Current ①	-24	
Power Dissipation	1.25	W
Power Dissipation	0.80	VV
Linear Derating Factor	10	mW/°C
Gate-to-Source Voltage	± 20	V
Junction and Storage Temperature Range	-55 to + 150	°C
	Drain- Source Voltage Continuous Drain Current, V <sub>GS</sub> @ -10V Continuous Drain Current, V <sub>GS</sub> @ -10V Pulsed Drain Current ① Power Dissipation Power Dissipation Linear Derating Factor Gate-to-Source Voltage	Drain- Source Voltage       -30         Continuous Drain Current, V <sub>GS</sub> @ -10V       -3.0         Continuous Drain Current, V <sub>GS</sub> @ -10V       -2.4         Pulsed Drain Current ①       -24         Power Dissipation       1.25         Power Dissipation       0.80         Linear Derating Factor       10         Gate-to-Source Voltage       ± 20

#### **Thermal Resistance**

	Parameter	Max.	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient®	100	°C/W

#### Electrical Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	-30			V	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.019		V/°C	Reference to 25°C, I <sub>D</sub> = -1mA
Book	Static Drain-to-Source On-Resistance			98	mΩ	V <sub>GS</sub> = -10V, I <sub>D</sub> = -3.0A ②
R <sub>DS(on)</sub>				165		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2.6A ②
V <sub>GS(th)</sub>	Gate Threshold Voltage	-1.0		-2.5	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
<b>9</b> fs	Forward Transconductance	3.1			S	$V_{DS} = -10V, I_{D} = -3.0A$
1	Drain-to-Source Leakage Current			-1.0		$V_{DS} = -24V, V_{GS} = 0V$
I <sub>DSS</sub>				-5.0	μA	V <sub>DS</sub> = -24V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 70°C
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			-100	nA	V <sub>GS</sub> = -20V
IGSS	Gate-to-Source Reverse Leakage			100	IIA	V <sub>GS</sub> = 20V
Q <sub>g</sub>	Total Gate Charge		9.5	14		$I_D = -3.0A$
Q <sub>gs</sub>	Gate-to-Source Charge		2.3	3.5	nC	V <sub>DS</sub> = -24V
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		1.6	2.4		V <sub>GS</sub> = -10V ②
t <sub>d(on)</sub>	Turn-On Delay Time		12			V <sub>DD</sub> = -15V ②
t <sub>r</sub>	Rise Time		18		ns	$I_D = -1.0A$
t <sub>d(off)</sub>	Turn-Off Delay Time		88		115	$R_G = 6.0\Omega$
t <sub>f</sub>	Fall Time		52			$V_{GS} = -10V$
C <sub>iss</sub>	Input Capacitance		510			V <sub>GS</sub> = 0V
Coss	Output Capacitance		71		pF	$V_{DS} = -25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		43			f = 1.0MHz

#### **Source-Drain Ratings and Characteristics**

	Parameter		Тур.	Max.	Units	Conditions	
Is	Continuous Source Current			4.0		MOSFET symbol	
	(Body Diode)	Diode)     -1.3		A	showing the		
I <sub>SM</sub>	Pulsed Source Current		24	04	-24	<b>A</b>	integral reverse G
	(Body Diode) ①			-24	·	p-n junction diode.	
V <sub>SD</sub>	Diode Forward Voltage	T		-1.2	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = -1.3A, V <sub>GS</sub> = 0V ②	
t <sub>rr</sub>	Reverse Recovery Time	T	17	26	ns	$T_J = 25^{\circ}C$ , $I_F = -1.3A$	
Q <sub>rr</sub>	Reverse Recovery Charge	T	12	18	nC	di/dt = -100A/μs ②	

#### Notes:

① Repetitive rating; pulse width limited by max. junction temperature.

② Pulse width  $\leq$  400 $\mu$ s; duty cycle  $\leq$  2%.

# International TOR Rectifier

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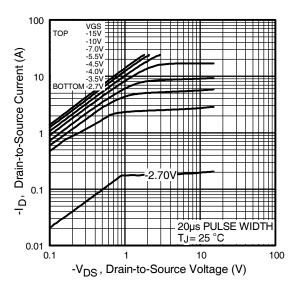


Fig 1. Typical Output Characteristics

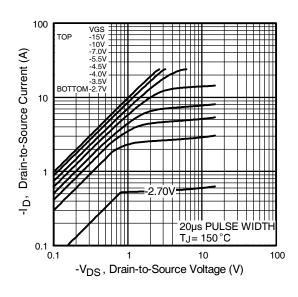


Fig 2. Typical Output Characteristics

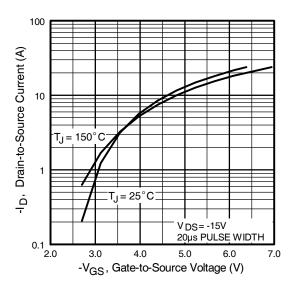
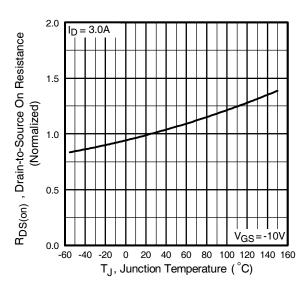
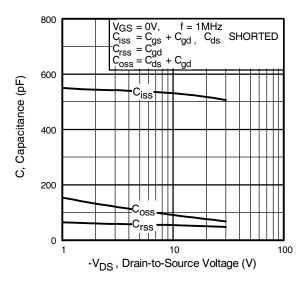


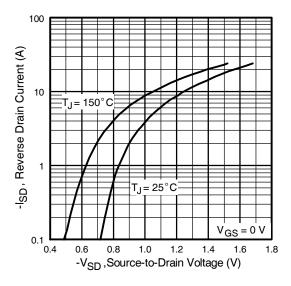
Fig 3. Typical Transfer Characteristics



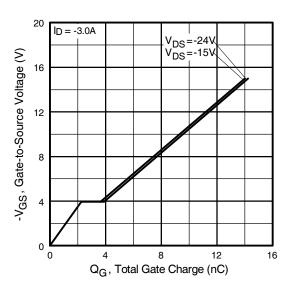
**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage

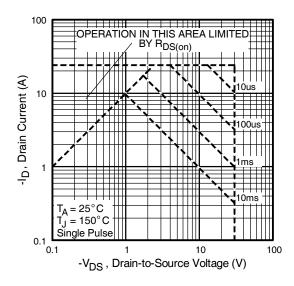
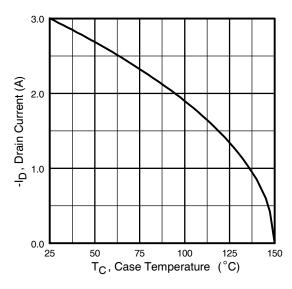


Fig 8. Maximum Safe Operating Area

# International IOR Rectifier

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**Fig 9.** Maximum Drain Current Vs. Case Temperature

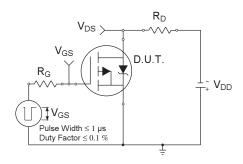


Fig 10a. Switching Time Test Circuit

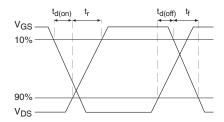


Fig 10b. Switching Time Waveforms

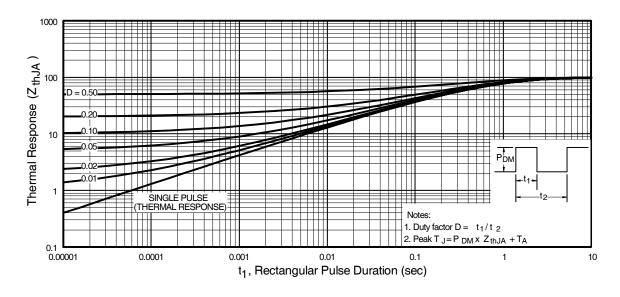
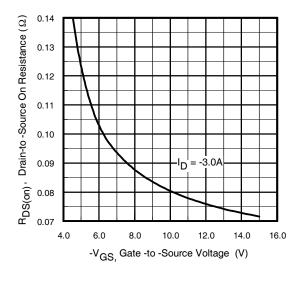


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

# International **TOR** Rectifier



**Fig 11.** Typical On-Resistance Vs. Gate Voltage

Fig 12. Typical On-Resistance Vs. Drain Current

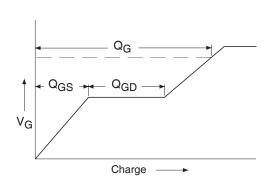


Fig 13a. Basic Gate Charge Waveform

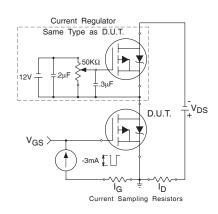


Fig 13b. Gate Charge Test Circuit

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# International TOR Rectifier

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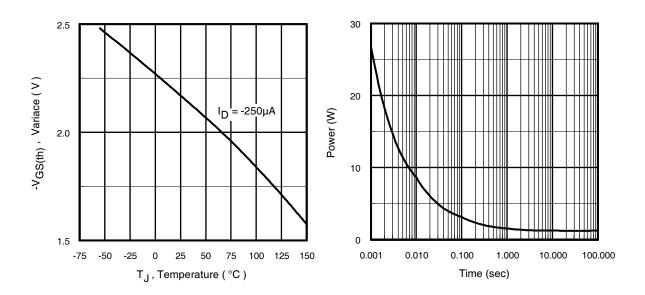


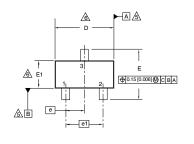
Fig 14. Threshold Voltage Vs. Temperature

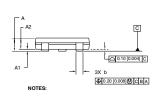
Fig 15. Typical Power Vs. Time

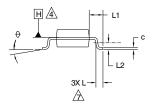


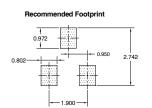
#### Micro3 (SOT-23) Package Outline

Dimensions are shown in millimeters (inches)









DIMENSIONS						
SYMBOL	MILLIM	ETERS	INCHES			
STIVIBOL	MIN	MAX	MIN	MAX		
Α	0.89	1.12	0.035	0.044		
A1	0.01	0.10	0.0004	0.004		
A2	0.88	1.02	0.035	0.040		
b	0.30	0.50	0.012	0.020		
С	0.08	0.20	0.003	0.008		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E1	1.20	1.40	0.047	0.055		
е	0.95	BSC	0.037	BSC		
e1	1.90	BSC	0.075	BSC		
L	0.40	0.60	0.016	0.024		
L1	0.54	REF	0.021	REF		
L2	0.25	BSC	0.010	BSC		
0	0	8	0	8		

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994
  2. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES);
  3. CONTROLLING BIMENSION. MILLIMETER

  \$\triangle \text{DATIM PLANE HIS LOCATED AT THE MOLD PARTITING LINE.}

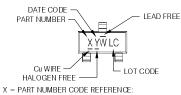
  \$\triangle \text{DATIM PLANE TO STORE TO STORE THE PLANE HIS LOCATED AT THE MOLD PARTITING LINE.}

  \$\triangle \text{DATIM PLANE HIS LOCATED AT THE MEASURED AT DATIM PLANE HIS DIMENSIONS DOCS.} NOT INCLUDE MOLD PROTRUSIONS OR INTERLEAD FLASH, MOLD PROTRUSIONS OR INTERLEAD FLASH SHALL NOT EXCEED 0.25 MM [0.010 INCH] PER SIDE.
- ⚠ DIMENSION L IS THE LEAD LENGTH FOR SOLDERING TO A SUBSTRATE.

  8. OUTLINE CONFORMS TO JEDEC OUTLINE TO 236 AB.

#### Micro3 (SOT-23/TO-236AB) Part Marking Information

Notes: This part marking information applies to devices produced after 02/26/2001



YEAR	Υ	WORK WEEK	W
2001	1	01	Α
2002	2	02	В
2003	3	03	С
2004	4	04	D
2005	5		
2006	6		
2007	7		
2008	8		
2009	9	7	7
2010	0	24	Х
		25	Υ

W = (27-52) IF PRECEDED BY A LETTER

YEAR

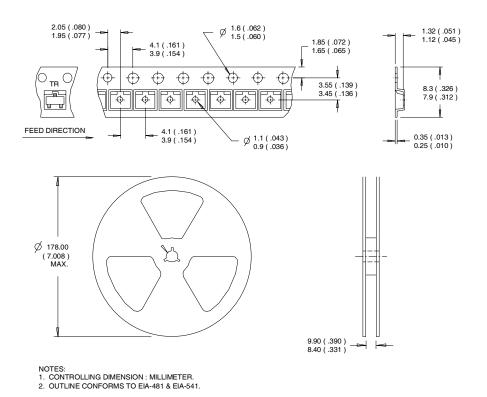
W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

- A = IRLML2402 B = IRLML2803
- C = IRLML6302
- D = IRLML5103
- E = IRLML6402
- F = IRLML6401
- G = IRLML2502H = IRLML5203
- I = IRLML0030 J = IRLML2030
- K = IRLML0100 L = IRLML0060
- M = IRLML0040N = IRLML2060P = IRLML9301R = IRLML9303
- 2001 2002 2003 28 29 2004 2005 30 D 2007 2009 2010

Note: For the most current drawing please refer to IR website at: http://www.irf.com/package/

#### Micro3™ Tape & Reel Information

Dimensions are shown in millimeters (inches)



Data and specifications subject to change without notice.



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